PI	TO-1595 10197115		R SHEET U.S. DEPARTMENT OF COMMERCIAL Patent and Trademark Office	
To	the Honorable Commissioner of Patents and Trademarks: Ple	ease	e record the attached original documents or copy thereof.	
1	Name of conveying party(ies):	2	Name and address of receiving party(ies):	
	Yeur-Luen Tu Chia-Shiung Tsai Min-Hwa Chi 1-15-07		Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.	
3	Nature of conveyance:  ■ Assignment	:	Additional name(s) & address(es) attached □ Yes ⊠ No	
	☐ Security Agreement ☐ Change of Name		•	
	Other: Execution Date: November 26, 2001			
4	Application number(s) or patent number(s): 10, 053	15	5 /	
	If this document is being filed together with a new application, the execution date of the application is: 11-26-01			
	A. Patent Application No(s).		B. Patent No(s)	
	Additional numbers attached? □ Yes ☒ No			
5	Name and address of party to whom correspondence concerning document should be mailed:	6	Total number of applications and patents involved: $\frac{1}{2}$	
	RANDY W. TUNG Tung & Associates 838 W. Long Lake Road	7	Total fee (37 CFR 3.41) \$40.00	
	Suite 120 Bloomfield Hills, Michigan 48302		□ Enclosed	
5005	EAREGAY1 00000030 10053151		Authorized to charge credit card (w/filing fee)	
584	40.00 QP	8	Deposit Account Number: 50-0484	
			(Attach duplicate copy of this page if paying by deposit account)	
	DO NOT USE THIS SPACE			
9	Statement and signature.  To the best of my knowledge and belief, the foregoing information the original document.  Randy W. Tung Name of Person Signing Registration No. 31,311  Signature	tion	is true and correct and any attached copy is a true copy of  January 15, 2002  Date	

Total number of pages including cover sheet, attachments, and document : 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

67,200-455

## **ASSIGNMENT**

WHEREAS, we, <u>YEUR-LUEN TU, CHIA-SHIUNG TSAI and MIN-HWA CHI</u> have invented certain improvements in CAPACITOR UNDER BITLINE (CUB) MEMORY CELL STRUCTURE EMPLOYING AIR GAP VOID ISOLATION for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, YEUR-LUENTU, CHIA-SHIUNG TSAI and MIN-HWA CHI, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 26th day of November, 2001, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters

1

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Patent that may be granted in pursuance of said application and any divisional, continuation or

continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to

any patent applications which may be filed on said invention in countries foreign to the United States

and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention

in its own name or through its designees, including subsidiaries, related companies or assignees,

under the International Convention or otherwise, and we further agree to execute all papers,

including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

LUENTU Chia Thing Tsai
CHIA-SHIUNG TSAI

**TUNG & ASSOCIATES** 838 W. Long Lake Road Suite 120

Bloomfield Hills, Michigan 48302

**RECORDED: 01/15/2002** 

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